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General Description

The MAX5945 quad network power controller is designed for use in IEEE 802.3af-compliant power-sourcing equipment (PSE). The device provides power devices (PD) discovery, classification, current-limit, and both DC and AC load disconnect detections. The MAX5945 can be used in either endpoint PSE (LAN switches/routers) or midspan PSE (power injector) applications. The MAX5945 is pin and function compatible with LTC4259A.

The MAX5945 can operate autonomously or be controlled by software through an I²C-compatible interface. Separate input and output data lines (SDAIN and SDAOUT) allow usage with optocouplers. The MAX5945 is a slave device. Its four address inputs allow 16 unique MAX5945 addresses. A separate INT output and four independent shutdown inputs (SHD_) allow fast response from a fault to port shutdown. A RESET input allows hardware reset of the device. A special watchdog feature allows the hardware to gracefully take over control if the software crashes. A cadence timing feature allows the MAX5945 to be used in midspan systems.

The MAX5945 is fully software configurable and programmable. A class-overcurrent detection function enables system power management to detect if a PD draws more current than the allowable amount for its class. Other features are input under/overvoltage lockout, overtemperature protection, output-voltage slew-rate limit during startup, power-good, and fault status. The MAX5945's programmability includes gate-charging current, currentlimit threshold, startup timeout, overcurrent timeout, autorestart duty cycle, PD disconnect AC detection threshold, and PD disconnect detection timeout.

The MAX5945 is available in a 36-pin SSOP package and is rated for both extended (-40°C to +85°C) and commercial (0°C to +70°C) temperature ranges.

Applications

Power-Sourcing Equipment (PSE) Power-Over-LAN/Power-Over-Ethernet Switches/Routers Midspan Power Injectors

Typical Operating Circuits appear at end of data sheet.

Features

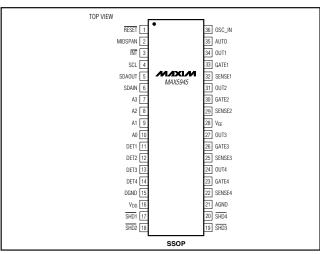
- ♦ IEEE 802.3af Compliant
- ♦ Pin and Function Compatible with LTC4259A
- ♦ Controls Four Independent, -48V-Powered **Ethernet Ports in Either Endpoint or Midspan PSE Applications**
- ♦ Wide Digital Power Input, VDIG, Common-Mode Range: VEE to (AGND + 7.7V)
- ♦ PD Violation of Class Current Protection
- ♦ PD Detection and Classification
- ♦ Provides Both DC and AC Load Removal **Detections**
- ♦ I²C-Compatible, 3-Wire Serial Interface
- **♦ Fully Programmable and Configurable Operation** Through I²C Interface
- ♦ Current Foldback and Duty-Cycle-Controlled/Programmable Current Limit
- ♦ Short-Circuit Protection with Fast Gate Pulldown
- **♦ Direct Fast Shutdown Control Capability**
- ♦ Programmable Direct Interrupt Output
- ♦ Watchdog Mode Enable Hardware Graceful Takeover

Ordering Information

PART	TEMP RANGE	PIN-PACKAGE
MAX5945CAX**	0°C to +70°C	36 SSOP
MAX5945EAX	-40°C to +85°C	36 SSOP

^{**}Future product—contact factory for availability.

Pin Configuration



Maxim Integrated Products 1

ABSOLUTE MAXIMUM RATINGS

(Voltages referenced to V _{EE} , unless otherwise noted.) AGND, DGND, DET , V _{DD} , RESET, A3, A2, A1, A0, SHD .
OSC_IN, SCL, SDAIN, OUT_ and AUTO0.3V to +80V
GATE_ (internally clamped, Note 1)0.3V to +11.4V
SENSE0.3V to +24V
V _{DD} , RESET, A3, A2, A1, A0, SHD_, OSC_IN, SCL, SDAIN and
AUTO to DGND0.3V to +7V
INT and SDAOUT to DGND0.3V to +12V
Maximum Current into INT, SDAOUT, DET80mA

Maximum Power Dissipation	
36-Pin SSOP (derate 11.4mW/°C	above +70°C)941mW
Operating Temperature Ranges:	
MAX5945EAX	40°C to +85°C
MAX5945CAX	0°C to +70°C
Storage Temperature Range	65°C to +150°C
Junction Temperature	+150°C
Lead Temperature (soldering, 10s).	+300°C

Note 1: GATE_ is internally clamped to 11.4V above VEE. Driving GATE_ higher than 11.4V above VEE may damage the device.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

(AGND = +32V to +60V, $V_{EE} = 0V$, V_{DD} to DGND = +3.3V, all voltages are referenced to V_{EE} , unless otherwise noted. Typical values are at AGND = +48V, DGND = +48V, $V_{DD} = (DGND + 3.3V)$, $T_A = +25$ °C. Currents are positive when entering the pin and negative otherwise.)

PARAMETER	SYMBOL	CONDI	TIONS	MIN	TYP	MAX	UNITS
POWER SUPPLIES							
	Vagnd	V _{AGND} - V _{EE}		32		60	
On anating a Valtagra Dagger	V _{DGND}			0		60] ,
Operating Voltage Range	\/	V _{DD} to V _{DGND} , V _{DGND} =	Vagnd	1.71		5.50	V
	V _{DD}	V _{DD} to V _{DGND} , V _{DGND} =	VEE	3.0		5.5	
OUT_ = VEE, SENSE_ = VEE, DET_ = AGND, all logic inputs open, SCL = SDAIN = VDD, INT and SDAOUT open; measured at AGND in power mode after GATE_ pullup					4.2	6.8	mA
	IDIG	All logic inputs high, mea		2.7	5.6		
GATE DRIVER AND CLAMPING	G						
GATE_ Pullup Current	I _{PU}	Power mode, gate drive of	-40	-50	-60	μΑ	
Weak GATE_ Pulldown Current	I _{PDW}	SHD_ = DGND, VGATE_ =	SHD_ = DGND, V _{GATE} _ = V _{EE} + 5V		40	50	μΑ
Maximum Pulldown Current	I _{PDS}	VSENSE = 1V, VGATE_ = VEE + 2V			100		mA
External Gate Drive	VGS	V _{GATE} - V _{EE} , power mode, gate drive on		9	10	11	V
CURRENT LIMIT							
Current-Limit Clamp Voltage	V _{SU_LIM}	Maximum V _{SENSE} allowe V _{OUT} = V _{EE} (Note 3)	d during current limit,	202	212	220	mV
Overcurrent Threshold After		Overcurrent VSENSE_ threshold allowed for	Default, class 0, class 3, class 4	178.5	196		.,
Startup	V _{FLT_LIM}	t ≤ t _{FAULT} after startup;	Class 1	49		61	mV
		VOUT_ = VEE	Class 2	90		104	
Foldback Initial OUT_ Voltage	V _{FLBK_ST}	V _{OUT} - V _{EE} , above which the current-limit trip voltage starts folding back			30		V
Foldback Final OUT_ Voltage	VFLBK_END	V _{OUT} - V _{EE} , above which voltage reaches V _{TH} _{FB}	n the current-limit trip		50		V

ELECTRICAL CHARACTERISTICS (continued)

(AGND = +32V to +60V, V_{EE} = 0V, V_{DD} to DGND = +3.3V, all voltages are referenced to V_{EE} , unless otherwise noted. Typical values are at AGND = +48V, DGND = +48V, V_{DD} = (DGND + 3.3V), T_{A} = +25°C. Currents are positive when entering the pin and negative otherwise.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Minimum Foldback Current- Limit Threshold	V _{TH_FB}	V _{OUT} _ = V _{AGND}		64		mV
SENSE_ Input Bias Current		VSENSE_ = VEE			-2	μΑ
SUPPLY MONITORS						
VEE Undervoltage Lockout	VEEUVLO	V _{AGND} - V _{EE} , (V _{AGND} - V _{EE}) increasing	27	28.5	30	V
V _{EE} Undervoltage-Lockout Hysteresis	VEEUVLOH			3		V
V _{EE} Overvoltage	V _{EE} _OV	(VAGND - VEE) > VEE_OV, VAGND increasing	61	62.5	64	V
VEE Overvoltage Hysteresis	Vovh			1		V
V _{EE} Undervoltage	V _{EE_UV}	(VAGND - VEE) < VEE_UV, VAGND decreasing	39	40	41	V
V _{DD} Overvoltage	V _{DD_OV}	(V _{DD} - V _{DGND}) > V _{DD_OV} , V _{DD} increasing	3.57	3.71	3.90	V
V _{DD} Undervoltage	V _{DD_UV}	(V _{DD} - V _{DGND}) < V _{DD_UV} , V _{DD} decreasing	2.55	2.82	2.97	V
V _{DD} Undervoltage Lockout	V _{DDUVLO}	Device operates when (V _{DD} - V _{DGND}) > V _{DDUVLO} , V _{DD} increasing			1.7	V
V _{DD} Undervoltage-Lockout Hysteresis	VDDHYS			120		mV
Thermal-Shutdown Threshold	T _{SHD}	Ports shut down and device resets if its junction temperature exceeds this limit, temperature increasing		+150		°C
Thermal-Shutdown Hysteresis	TSHDH			20		°C
OUTPUT MONITOR						
OUT_ Input Current	IBOUT	V _{OUT} = V _{AGND} , all modes			2	μΑ
Idle Pullup Current at OUT_	I _{DIS}	OUT_ discharge current, detection and classification off, port shutdown, VOUT_ = VAGND - 2.8V	200		260	μА
PGOOD High Threshold	PGTH	V _{OUT} V _{EE} , OUT_ decreasing	1.8	2.0	2.2	V
PGOOD Hysteresis	PGHYS			220		mV
PGOOD Low-to-High Glitch Filter	tpgood	Minimum time PGOOD has to be high to set bit in register 10h	2		4	ms
LOAD DISCONNECT						
DC Load Disconnect Threshold	V _{DCTH}	Minimum V _{SENSE} allowed before disconnect (DC disconnect active), V _{OUT} = V _{EE}	3	4	5	mV



ELECTRICAL CHARACTERISTICS (continued)

(AGND = +32V to +60V, V_{EE} = 0V, V_{DD} to DGND = +3.3V, all voltages are referenced to V_{EE} , unless otherwise noted. Typical values are at AGND = +48V, DGND = +48V, V_{DD} = (DGND + 3.3V), V_{A} = +25°C. Currents are positive when entering the pin and negative otherwise.)

PARAMETER	SYMBOL	COND	MIN	TYP	MAX	UNITS	
AC Load Disconnect Threshold (Note 4)	IACTH	Current into DET_, ACD_ OSC_IN = 2.2V	300	325	350	μA	
Oscillator Buffer Gain	Aosc	V _{DET_} / V _{OSC_IN} , ACD_E C _{DET} = 400nF	N_ bit = high,	2.92	2.98	3.04	V/V
OSC_IN Fail Threshold (Note 5)	Vosc_fail	Port will not power on if V ACD_EN_ bit = high	OSC_IN < VOSC_FAIL and	1.8	1.9	2.1	V
OSC_IN Input Resistance	Zosc	OSC_IN input impedance are active	e when all the ACD_EN_	100			kΩ
OSC_IN Input Capacitance	C _{OSC_IN}				5		рF
Load Disconnect Timer	tDISC	Time from VSENSE < VDC < IACTH to gate shutdow		300		400	ms
DETECTION							
Detection Probe Voltage (First Phase)	V _{DPH1}	VAGND - VDET_ during the	e first detection phase	3.8	4	4.2	V
Detection Probe Voltage (Second Phase)	V _{DPH2}	VAGND - VDET_ during the phase	V _{AGND} - V _{DET} during the second detection phase				V
Current-Limit Protection	I _{DLIM}	V _{DET} = V _{AGND} , during of current through DET_	1.5	1.75	2.0	mA	
Short-Circuit Threshold	V _{DCP}	If VAGND - VOUT < VDCP a phase a short circuit to AC		1.62		V	
Open-Circuit Threshold	I _{D_OPEN}	First point measurement open condition		12.5		μA	
Resistor Detection Window	RDOK	(Note 7)		18.6		26.5	kΩ
Resistor Rejection Window	R _{DBAD}	Detection rejects lower v	alues			16	kΩ
Tiesistoi Tiejection Window	LIDBAD	Detection rejects higher	values	30			1/22
CLASSIFICATION		T					
Classification Probe Voltage	V _{CL}	VAGND - VDET_ during cla	assification	16		20	V
Current-Limit Protection	ICILIM	V _{DET} = V _{AGND} , during of measure current through		50		75	mA
			Class 0, class 1	5.5	6.5	7.5	mA
Classification Comment		Classification current	Class 1, class 2	13.5	14.5	15.5	
Classification Current Thresholds	ICL	thresholds between	Class 2, class 3	21.5	23	24.5	
		classes	Class 3, class 4	31	33	35	
			>Class 4	45	48	51	
DIGITAL INPUTS/OUTPUTS (I	REFERRED t	o DGND)					
Digital Input Low	V _{IL}					0.9	V
Digital Input High	VIH			2.4			V

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ELECTRICAL CHARACTERISTICS (continued)

(AGND = +32V to +60V, V_{EE} = 0V, V_{DD} to DGND = +3.3V, all voltages are referenced to V_{EE} , unless otherwise noted. Typical values are at AGND = +48V, DGND = +48V, V_{DD} = (DGND + 3.3V), T_{A} = +25°C. Currents are positive when entering the pin and negative otherwise.)

PARAMETER	SYMBOL	CONDIT	TIONS	MIN	TYP	MAX	UNITS
Internal Input Pullup/Pulldown Resistor	R _{DIN}	Pullup (pulldown) resistor default level	to V _{DD} (DGND) to set	25	50	75	kΩ
Open-Drain Output Low Voltage	V _{OL}	I _{SINK} = 15mA			0.4	V	
Open-Drain Leakage	loL	Open-drain high impedan	ce, V _O = 3.3V			2	μΑ
TIMING							
Startup Time	tstart	Time during which a current limit set by V _{SU_LIM} is allowed, starts when the GATE_ is turned on (Note 8)			60	70	ms
Fault Time	tFAULT	Maximum allowed time for condition set by VFLT_LIM		50	60	70	ms
Port Turn-Off Time	tOFF	Minimum delay between a does not apply in the case		0.5	0.75	1.0	ms
Detection Time	tDET	Maximum time allowed before detection is completed				320	ms
Midspan Mode Detection Delay	t _{DMID}		2.0		2.4	S	
Classification Time	tCLASS	Time allowed for classification				40	ms
VEEUVLO Turn-On Delay	t _{DLY}	Time V _{AGND} must be above the V _{EEUVLO} thresholds before the device operates				4	ms
	†RESTART	Time a port has to wait before turning on after an overcurrent fault, RSTR_EN bit = high	RSTR bits = 00		16 x tFAULT		
Restart Timer			RSTR bits = 01		32 x tfault		ms
			RSTR bits = 10		64 x tfault		
			RSTR bits = 11		0		
Watchdog Clock Period	twD	Rate of decrement of the	_		164		ms
TIMING CHARACTERISTICS for			6)	T			
Serial Clock Frequency	fscl	(Note 9)	(Note 9)			400	kHz
Bus Free Time Between a STOP and a START Condition	tBUF	(Note 9)		1.2			μs
Hold Time for Start Condition	tHD, STA	(Note 9)		0.6			μs
Low Period of the SCL Clock	tLOW	(Note 9)		1.2			μs
High Period of the SCL Clock	tHIGH	(Note 9)		0.6			μs



ELECTRICAL CHARACTERISTICS (continued)

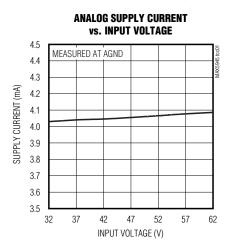
 $(AGND = +32V \text{ to } +60V, V_{EE} = 0V, V_{DD} \text{ to } DGND = +3.3V, \text{ all voltages are referenced to } V_{EE}, \text{ unless otherwise noted.}$ Typical values are at AGND = +48V, DGND = +48V, V_{DD} = (DGND + 3.3V), T_A = +25°C. Currents are positive when entering the pin and negative otherwise.)

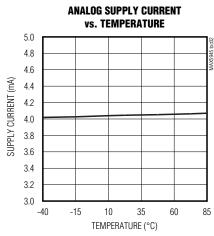
PARAMETER	SYMBOL	CONDITIONS	MIN TY	YP MAX	UNITS
Setup Time for a Repeated START Condition (Sr)	tsu, sta	(Note 9)	0.6		μs
Data Hold Time	thd, dat	(Note 9)	0	150	ns
Data Setup Time	tsu, dat	(Note 9)	100		ns
Rise Time of Both SDA and SCL Signals, Receiving	tR	(Note 9)	20 + 0.1C _B	300	ns
Fall Time of SDA Transmitting	tF	(Note 9)	20 + 0.1C _B	300	ns
Setup Time for STOP Condition	tsu, sto	(Note 9)	0.6		μs
Capacitive Load for Each Bus Line	Св	(Note 9)		400	pF
Pulse Width of Spike Suppressed	tsp	(Note 9)		50	ns

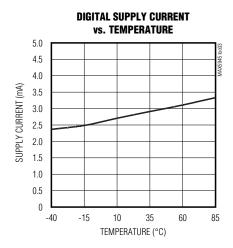
- **Note 2:** Default values. The charge/discharge currents are programmable through the serial interface (see the *Register Map and Description* section).
- **Note 3:** Default values. The current-limit thresholds are programmed through the I²C-compatible serial interface (see the *Register Map and Description* section).
- Note 4: This is the default value. Threshold can be programmed through serial interface R23h[2:0].
- Note 5: AC disconnect works only if VDD VDGND ≥ 3V.
- Note 6: tDISC can also be programmed through the serial interface (R29h) (see the Register Map and Description section).
- Note 7: R_D = (V_{OUT_2} V_{OUT_1}) / (I_{DET_2} I_{DET_1}). V_{OUT_1}, V_{OUT_2}, I_{DET_2} and I_{DET_1} represent the voltage at OUT_ and the current at DET_ during phase 1 and 2 of the detection.
- **Note 8:** Default values. The startup and fault times can also be programmed through the I²C serial interface (see the *Register Map and Description* section).
- Note 9: Guaranteed by design. Not subject to production testing.

Typical Operating Characteristics

 $(V_{EE} = -48V, V_{DD} = +3.3V, AUTO = AGND = DGND = 0V, \overline{RESET} = \overline{SHD}_{-} = unconnected, R_{SENSE} = 0.5\Omega, all registers = default setting, T_A = +25°C, unless otherwise noted.)$

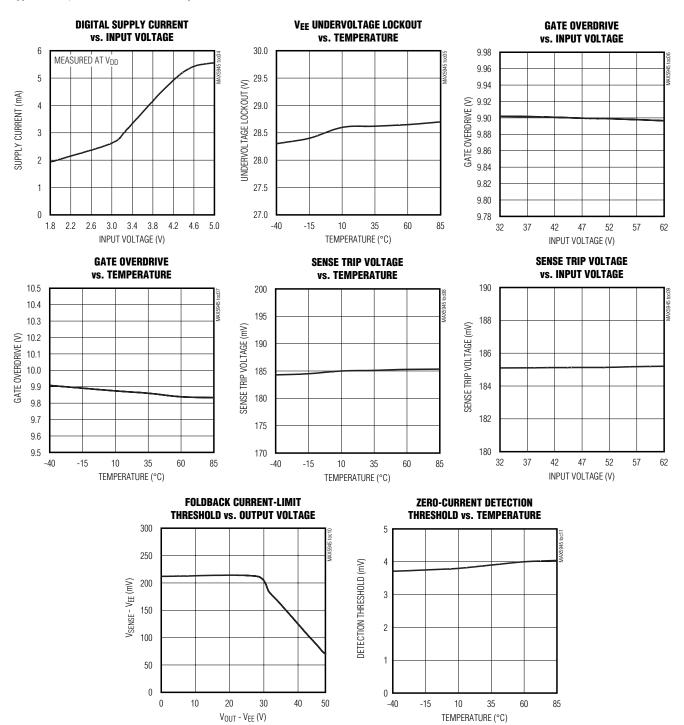






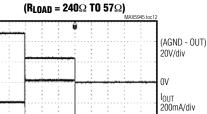
Typical Operating Characteristics (continued)

 $(V_{EE} = -48V, V_{DD} = +3.3V, AUTO = AGND = DGND = 0V, \overline{RESET} = \overline{SHD}_{=} unconnected, R_{SENSE} = 0.5\Omega$, all registers = default setting, $T_A = +25^{\circ}C$, unless otherwise noted.)



Typical Operating Characteristics (continued)

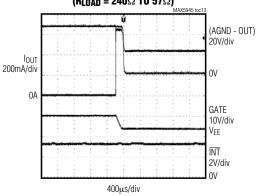
(V_{FE} = -48V, V_{DD} = +3.3V, AUTO = AGND = DGND = 0V, RESET = SHD_ = unconnected, R_{SENSE} = 0.5Ω, all registers = default setting, $T_A = +25$ °C, unless otherwise noted.)



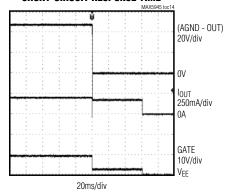
OVERCURRENT TIMEOUT

GATE 10V/div V_{EE} ĪNT 2V/div 0V 20ms/div

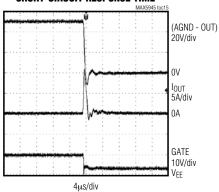
OVERCURRENT RESPONSE WAVEFORM $(R_{LOAD} = 240\Omega \text{ TO } 57\Omega)$



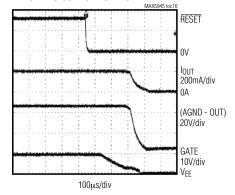
SHORT-CIRCUIT RESPONSE TIME



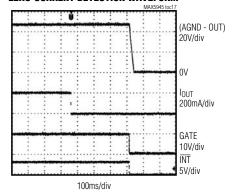
SHORT-CIRCUIT RESPONSE TIME



RESET TO OUTPUT TURN-OFF DELAY

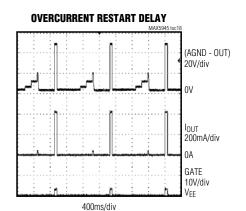


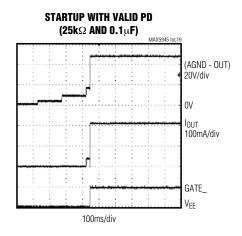
ZERO-CURRENT DETECTION WAVEFORM

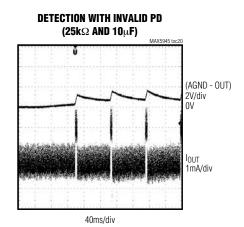


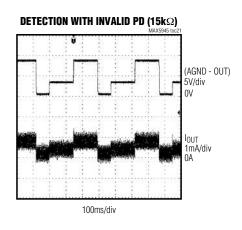
Typical Operating Characteristics (continued)

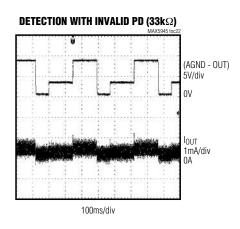
 $(V_{EE} = -48V, V_{DD} = +3.3V, AUTO = AGND = DGND = 0V, \overline{RESET} = \overline{SHD}_{=} unconnected, R_{SENSE} = 0.5\Omega$, all registers = default setting, $T_A = +25^{\circ}C$, unless otherwise noted.)

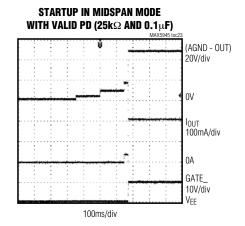








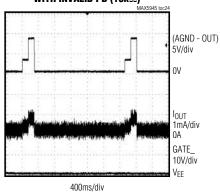




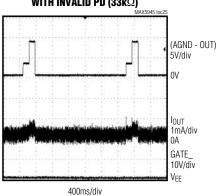
Typical Operating Characteristics (continued)

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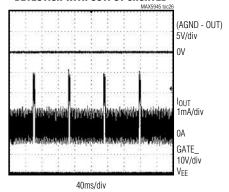
DETECTION WITH MIDSPAN MODE WITH INVALID PD (15 $k\Omega$)



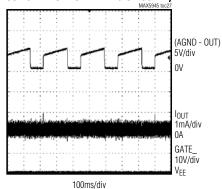
DETECTION WITH MIDSPAN MODE WITH INVALID PD (33k Ω)



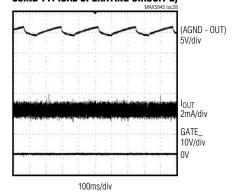
DETECTION WITH OUTPUT SHORTED



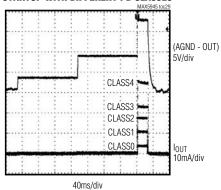
DETECTION WITH INVALID PD (OPEN CIRCUIT, USING TYPICAL OPERATING CIRCUIT 1)



DETECTION WITH INVALID PD (OPEN CIRCUIT, USING TYPICAL OPERATING CIRCUIT 2)



STARTUP WITH DIFFERENT PD CLASSES



_Pin Description

PIN	NAME	FUNCTION
1	RESET	Hardware Reset. Pull RESET low for at least 300μs to reset the device. All internal registers reset to their default value. The address (A0–A3), and AUTO and MIDSPAN input logic levels latch on during low-to-high transition of RESET. Internally pulled up to V _{DD} with 50kΩ resistor.
2	MIDSPAN	MIDSPAN Mode Input. An internal $50k\Omega$ pulldown resistor to DGND sets the default mode to endpoint PSE operation (power-over-signal pairs). Pull MIDSPAN TO V_{DIG} to set MIDSPAN operation. The MIDSPAN value latches after the IC is powered up or reset (see the <i>PD Detection</i> section).
3	ĪNT	Open-Drain Interrupt Output. $\overline{\text{INT}}$ goes low whenever a fault condition exists. Reset the fault condition using software or by pulling $\overline{\text{RESET}}$ low (see the <i>Interrupt</i> section of the <i>Detailed Description</i> for more information about interrupt management).
4	SCL	Serial Interface Clock Line
5	SDAOUT	Serial Output Data Line. Connect the data line optocoupler input to SDAOUT (see the <i>Typical Application Circuit</i>). Connect SDAOUT to SDAIN if using a 2-wire I ² C-compatible system.
6	SDAIN	Serial Interface Input Data Line. Connect the data line optocoupler output SDAIN (see the <i>Typical Application Circuit</i>). Connect SDAIN to SDAOUT if using a 2-wire wire I ² C-compatible system.
7–10	A3, A2, A1, A0	Address Bits. A3, A2, A1, and A0 form the lower part of the device's address. Address inputs default high with an internal $50k\Omega$ pullup resistor to V_{DD} . The address values latch when V_{DD} or V_{EE} ramps up and exceeds its UVLO threshold or after a reset. The 3 MSB bits of the address are set to 010.
11–14	DET1, DET2, DET3, DET4	Detection and Classification Voltage Outputs. Use DET1 to set the detection and classification probe voltages on port 1. Use DET1 for the AC voltage sensing of port 1 when using the AC disconnect scheme (see the <i>Typical Application Circuit</i>).
15	DGND	Connect to Digital Ground
16	V_{DD}	Positive Digital Supply. Connect to digital supply (referenced to DGND).
17–20	SHD1, SHD2, SHD3, SHD4	Port Shutdown Inputs. Pull \overline{SHD} low to turn off the external FET on port Internally pulled up to V_{DD} with a $50k\Omega$ resistor.
21	AGND	Analog Ground. Connect to the high-side analog supply.
22, 25, 29, 32	SENSE4, SENSE3, SENSE2, SENSE1	MOSFET Source Current-Sense Negative Inputs. Connect to the source of the power MOSFET and connect a current-sense resistor between SENSE_ and VEE (see the <i>Typical Application Circuit</i>).
23, 26, 30, 33	GATE4, GATE3, GATE2, GATE1	Port_ MOSFET Gate Drivers. Connect GATE_ to the gate of the external FET (see the <i>Typical Application Circuit</i>).
24, 27, 31, 34	OUT4, OUT3, OUT2, OUT1	MOSFET Drain-Output Voltage Senses. Connect OUT_ to the power MOSFET drain through a resistor (100 Ω to 100k Ω). The low leakage at OUT_ limits the drop across the resistor to less than 100mV (see the <i>Typical Application Circuit</i>).
28	VEE	Low-Side Analog Supply Input. Connect the low-side analog supply to V_{EE} (-48V). Bypass with a 1 μ F capacitor between AGND and V_{EE} .
35	AUTO	AUTO or SHUTDOWN Mode Input. Force high to enter AUTO mode after a reset or power-up. Drive low to put the MAX5945 into SHUTDOWN mode. In SHUTDOWN mode, software controls the operational modes of the MAX5945. A $50k\Omega$ internal pulldown resistor defaults AUTO low. AUTO latches when V_{DD} or V_{EE} ramps up and exceeds its UVLO threshold or when the device resets. Software commands can take the MAX5945 out of AUTO while AUTO is high.
36	OSC_IN	Oscillator Input. AC-disconnect detection function uses OSC_IN. Connect a 100Hz \pm 10%, 2V _{P-P} \pm 5%, +1.2V offset sine wave to OSC_IN. If the oscillator positive peak falls below the OSC_FAIL threshold of 2V, the ports that have the AC function enabled shut down and are not allowed to power up. When not using the AC-disconnect detection function, leave OSC_IN unconnected.

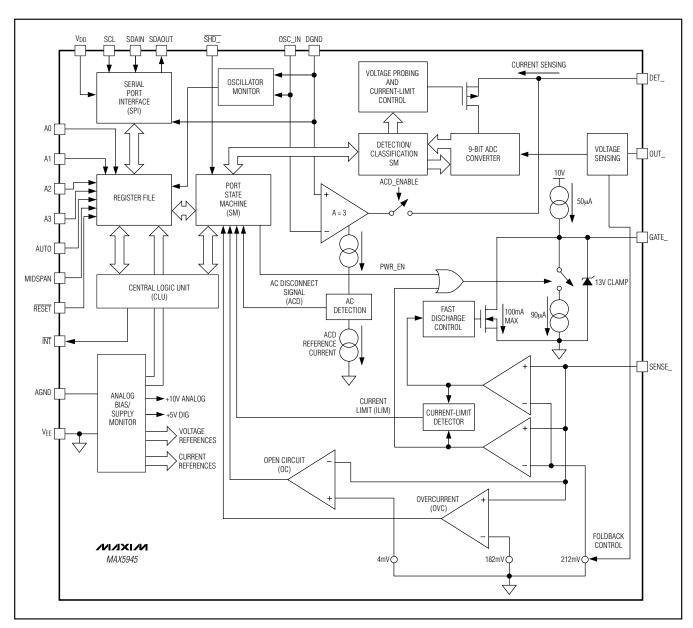


Figure 1. MAX5945 Functional Diagram

Detailed Description

The MAX5945 four-port network power controller controls -32V to -60V negative supply rail systems. Use the MAX5945, which is compliant with the IEEE 802.3af standard for PSE in power-over-LAN applications. The MAX5945 provides PD discovery, classification, current limit, both DC and AC load disconnect detections, and other necessary functions for an IEEE 802.3af-compli-

ant PSE. The MAX5945 can be used in either endpoint PSE (LAN switch/router) or midspan PSE (power injector) applications.

The MAX5945 is fully software-configurable and programmable with more than 25 internal registers. The device features an I²C-compatible, 3-wire serial interface and a class-overcurrent detection. The class-overcurrent detection function enables system power man-

agement where it detects a PD that draws more current than the allowable amount for its class. The MAX5945's extensive programmability enhances system flexibility and allows for uses in other applications.

The MAX5945 has four different operating modes: auto mode, semi-auto mode, manual mode, and shutdown mode (see the *Operation Modes* section). A special watchdog feature allows the hardware to gracefully take over control if the software/firmware crashes. A cadence timing feature allows the MAX5945 to be used in midspan systems.

The MAX5945 provides input undervoltage lockout, input undervoltage detection, input overvoltage lockout, overtemperature protection, output-voltage slew-rate limit during startup, power-good status, and fault status. The MAX5945's programmability includes gate-charging current, current-limit threshold, startup timeout, overcurrent timeout, autorestart duty cycle, PD disconnect AC detection threshold and PD disconnect detection timeout.

The MAX5945 communicates with the system microcontroller through an I²C-compatible interface. The MAX5945 features separate input and output data lines (SDAIN and SDAOUT) for use with optocoupler isolation. The MAX5945 is a slave device. Its four address inputs allow 16 unique MAX5945 addresses. A separate INT output and four independent shutdown inputs (SHD_) allow fast interrupt signals between the MAX5945 and the microcontroller. A RESET input allows hardware reset of the device.

Reset

Reset is a condition the MAX5945 enters after any of the following conditions:

- After power-up (VEE and VDD rise above their UVLO thresholds).
- Hardware reset. The RESET input is driven low and up high again any time after power-up.
- Software reset. Writing a 1 into R1Ah[4] any time after power-up.
- Thermal shutdown.

During a reset, the MAX5945 resets its register map to the reset state as shown in Table 30 and latches in the state of AUTO (pin 35) and MIDSPAN (pin 2). During normal operation, changes at the AUTO and MIDSPAN inputs are ignored. While the condition that caused the reset persists (i.e., high temperature, RESET input low, or UVLO conditions) the MAX5945 will not acknowledge any addressing from the serial interface.

Port Reset (R1Ah[3:0])

Set high anytime during normal operation to turn off power and clear the events and status registers of the corresponding port. Port reset only resets the events and status registers.

Operation Modes

The MAX5945 contains four independent but identical state machines to provide reliable and real-time control of the four network ports. Each state machine has four different operating modes: auto, semi-auto, manual, and shutdown. Auto mode allows the device to operate automatically without any software supervision. Semiauto mode, upon request, continuously detects and classifies a device connected to a port but does not power up that port until instructed by software. Manual mode allows total software control of the device and is useful in system diagnostic. Shutdown mode terminates all activities and securely turns off power to the ports. Switching between AUTO, SEMI, or MANUAL mode does not take effect until the part finishes its current task. When the port is set into SHUTDOWN mode, all the port operations are immediately stopped and the port remains idle until SHUTDOWN is exited.

Automatic (AUTO) Mode

Enter automatic (AUTO) mode by forcing the AUTO input high prior to a reset, or by setting R12h[P_ M1,P_M0] to [1,1] during normal operation (see Tables 15 and 15a). In AUTO mode, the MAX5945 performs detection, classification, and powers up the port automatically once a valid PD is detected at the port. If a valid PD is not detected at the port, the MAX5945 repeats the detection routine continuously until a valid PD is detected.

Going into AUTO mode, the DET_EN and CLASS_EN bits are set to high and stay high unless changed by software. Using software to set DET_EN and/or CLASS_EN low causes the MAX5945 to skip detection and/or classification. As a protection, disabling the detection routine in AUTO mode will not allow the corresponding port to power up, unless the DET_BYP (R23H[4]) is set to 1.

The AUTO status is latched into the register only during a reset. Any changes to the AUTO input after reset is ignored.

Semi-Automatic (SEMI) Mode

Enter semi-automatic (SEMI) mode by setting R12h[P_M1,P_M0] to [1,0] during normal operation (see Tables 15 and 15a). In SEMI mode, the MAX5945, upon request, performs detection and/or classification repeatedly but does not power up the port(s), regardless of the status of the port connection.

Setting R19h[PWR_ON_] (Table 21) high immediately terminates detection/classification routines and turns on power to the port(s).

R14h[DET_EN_, CLASS_EN_] default to low in SEMI mode. Use software to set R14h[DET_EN_, CLASS_EN_] to high to start the detection and/or classification routines. R14h[DET_EN_, CLASS_EN_] are reset every time the software commands a power-off of the port (either through reset or PWR_OFF). In any other case, the status of the bits is left unchanged (including when the state machine turns off the power because a load disconnect or a fault condition is encountered).

MANUAL Mode

Enter MANUAL mode by setting R12h[P_M1,P_M0] to [0,1] during normal operation (see Tables 15 and 15a). MANUAL mode allows the software to dictate any sequence of operation. Write a 1 to both R14h[DET_EN_] and R14h[CLASS_EN_] start detection and classification operations, respectively, and in that priority order. After execution, the command is cleared from the register(s). PWR_ON_ has highest priority. Setting PWR_ON_ high at any time causes the device to immediately enter the powered mode. Setting DET_EN and CLASS_EN high at the same time causes detection to be performed first. Once in the powered state, the device ignores DET_EN_ or CLASS_EN_ commands.

When switching to MANUAL mode from another mode, DET_EN_, CLASS_EN_ default to low. These bits become pushbutton rather than configuration bits (i.e., writing ones to these bits while in MANUAL mode commands the device to execute one cycle of detection and/or classification. The bits are reset back to zeros at the end of the execution). Putting the MAX5945 into shutdown mode immediately turns off power and halts all operations to the corresponding port. The event and status bits of the affected port(s) are also cleared. In SHUTDOWN mode, the DET_EN_, CLASS_EN_, and PWR_ON_ commands are ignored.

In SHUTDOWN mode, the serial interface operates normally.

Watchdog

R1Dh, R1Eh, and R1Fh registers control watchdog operation. The watchdog function, when enabled, allows the MAX5945 to gracefully take over control or securely shut down the power to the ports in case of software/firmware crashes. Contact the factory for more details.

PD Detection

When PD detection is activated, the MAX5945 probes the output for a valid PD. After each detection cycle, the device sets the DET_END_ bit R04h/05h[3:0] high and reports the detection results in the status registers R0Ch[2:0], R0Dh[2:0], R0Eh[2:0], and R0Fh[2:0]. The DET_END_ bit is reset to low when read through R05h or after a port reset. Both DET_END_ bit status registers are cleared after the port powers down.

A valid PD has a $25 k\Omega$ discovery signature characteristic as specified in the IEEE 802.3af standard. Table 1 shows the IEEE 802.3af specification for a PSE detecting a valid PD signature (see the *Typical Application Circuit* and Figure 2). The MAX5945 can probe and categorize different types of devices connected to the port such as a valid PD, an open circuit, a low resistive load, a high resistive load, a high capacitive load, a positive DC supply, or a negative DC supply.

During detection, the MAX5945 turns off the external MOSFET and forces two probe voltages through the DET_ input. The current through the DET_ input is measured as well as the voltage at OUT_. A two-point slope measurement is used as specified by the IEEE 802.3af standard to verify the device connected to the port. The MAX5945 implements appropriate settling times and a 100ms digital integration to reject 50Hz/60Hz power-line noise coupling.

An external diode, in series with the DET_ input, restricts PD detection to the 1st quadrant as specified by the IEEE 802.3af standard. To prevent damage to non-PD devices and to protect itself from an output short circuit, the MAX5945 limits the current into DET_ to less than 2mA maximum during PD detection.

In midspan mode, the MAX5945 waits 2.2s before attempting another detection cycle after every failed detection. The first detection, however, happens immediately after issuing the detection command.

Power Device Classification (PD Classification)

During the PD classification mode, the MAX5945 forces a probe voltage (-18V) at DET_ and measures the current into DET_. The measured current determines the class of the PD.

After each classification cycle, the device sets the CL_END_ bit (R04h/05h[7:4]) high and reports the classification results in the status registers R0Ch[6:4], R0Dh[6:4], R0Eh[6:4], and R0Fh[6:4]. The CL_END_ bit is reset to low when read through register R05h or after a port reset. Both CL_END_ bit status registers are cleared after the port powers down.

Table 1. PSE PI Detection Modes Electrical Requirement (Table 33-2 of the IEEE 802.3af Standard)

PARAMETER	SYMBOL	MIN	MAX	UNITS	ADDITIONAL INFORMATION
Open-Circuit Voltage	Voc	_	30	V	In detection mode only
Short-Circuit Current	Isc		5	mA	In detection mode only
Valid Test Voltage	V _{VALID}	2.8	10	V	
Voltage Difference Between Test Points	ΔVTEST	1	_	V	
Time Between Any Two Test Points	t _{BP}	2	_	ms	This timing implies a 500Hz maximum probing frequency
Slew Rate	VSLEW	_	0.1	V/µs	
Accept Signature Resistance	RGOOD	19	26.5	kΩ	
Reject Signature Resistance	R _{BAD}	< 15	> 33	kΩ	
Open-Circuit Resistance	ROPEN	500	_	kΩ	
Accept Signature Capacitance	CGOOD		150	nF	
Reject Signature Capacitance	C _{BAD}	10	_	μF	
Signature Offset Voltage Tolerance	Vos	0	2.0	V	
Signature Offset Current Tolerance	los	0	12	μА	

Table 2. PSE Classification of a PD (Table 33-4 of the IEEE 802.3af Standard)

MEASURED ICLASS (mA)	CLASSIFICATION
0 to 5	Class 0
> 5 and < 8	May be Class 0 and 1
8 to 13	Class 1
> 13 and < 16	May be Class 0, 1, or 2
16 to 21	Class 2
> 21 and < 25	May be Class 0, 2, or 3
25 to 31	Class 3
> 31 and <35	May be Class 0, 3, or 4
35 to 45	Class 4
> 45 and < 51	May be Class 0 or 4

Table 2 shows the IEEE 802.3af requirement for a PSE classifying a PD at the power interface (PI).

Powered State

When the part enters PWR MODE, the tSTART and tDISC timers are reset. Before turning on the power, the part

checks if any other port is not turning on and if the tFAULT timer is zero. Another check is performed if the ACD_EN bit is set, in this case OSC_FAIL bit must be low (oscillator is okay) for the port to be powered.

If these conditions are met then the part enters startup where it turns on power to the port. An internal signal, POK_, is asserted high when V_{OUT} is within 2V from V_{EE} . PGOOD_ status bits are set high if POK_ stays high longer than t_{PGOOD} . PGOOD immediately resets when POK goes low.

The PWR_CHG bit sets when a port powers up or down. PWR_EN sets when a port powers up and resets when a port shuts down. The port shutdown timer lasts 0.5ms and prevents other ports from turning off during that period, except in the case of emergency shutdowns (RESET = L, RESET_IC = H, VEEUVLO, VDDUVLO, and TSHD).

The MAX5945 always checks the status of all ports before turning off. A priority logic system determines the order to prevent the simultaneous turn-on or turn-off of the ports. The port with the lesser ordinal number gets priority over the others (i.e., port 1 turns on first, port 2 second, port 3 third and port 4 fourth). Setting PWR_OFF_ high turns off power to the corresponding port.

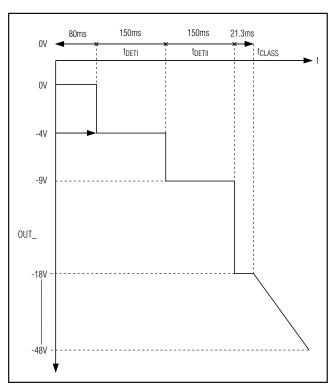


Figure 2. Detection, Classification, and Power-Up Port Sequence

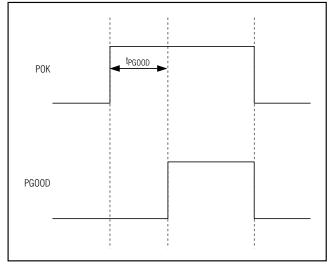


Figure 3. PGOOD Timing

Overcurrent Protection

A sense resistor (Rs), connected between SENSE_ and VFF, monitors the load current. Under all circumstances, the voltage across Rs never exceeds the threshold V_{SU LIM}. If SENSE_ exceeds V_{SU LIM}, an internal current-limiting circuit regulates the GATE voltage, limiting the current to ILIM = VSU LIM / Rs. During transient conditions, if the SENSE_ voltage exceeds VSU LIM, a fast pulldown circuit activates to quickly recover from the current overshoot. During startup, if the current-limit condition persists, when the startup timer, tSTART, times out, the port shuts off and the STRT_FLT_ bit is set. In normal powered state, the MAX5945 checks for overcurrent conditions as determined by VFLT LIM = ~88% of VSU LIM. The tFAULT counter sets the maximum allowed continuous overcurrent period. The tFAULT counter increases when VSENSE exceeds VFLT_LIM and decreases at a slower pace when VSENSE drops below VFLT LIM. A slower decrement for the tFAULT counter allows for detecting repeated short-duration overcurrents. When the counter reaches the trault limit, the MAX5945 powers off the port and asserts the IMAX_FLT_ bit. For a continuous overstress, a fault latches exactly after a period of teault. Vsu IIM, is programmable using R27h[4-7]. tfault is programmable using R16h[2-3] and R28[4-7].

After power-off due to an overcurrent fault, and if the RSTR_EN bit is set, the tFAULT timer is not immediately reset but starts decrementing at the same slower pace. The MAX5945 allows the port to be powered on only when the tFAULT counter is at zero. This feature sets an automatic duty-cycle protection to the external MOSFET to avoid overheating. The duty cycle is programmable using R16h[6-7].

The MAX5945 continuously flags when the current exceeds the maximum current allowed for the class as indicated in the CLASS status register. When class overcurrent occurs, the MAX5945 sets the IVC bit in register R09h.

Foldback Current

During startup and normal operation, an internal circuit senses the voltage at OUT_ and reduces the current-limit value when (V_{OUT_-} - V_{EE}) > 30V. The foldback function helps to reduce the power dissipation on the FET. The current limit eventually reduces to 1/3 of I_{LIM} when (V_{OUT_-} - V_{EE}) > 50V (see Figure 4).

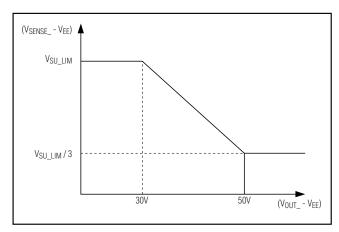


Figure 4. Foldback Current Characteristics

MOSFET Gate Driver

Connect the gate of the external n-channel MOSFET to GATE_. An internal 50µA current source pulls GATE_ to (VEE + 10V) to turn on the MOSFET. An internal 40µA current source pulls down GATE_ to VEE to turn off the MOSFET.

The pullup and pulldown current controls the maximum slew rate at the output during turn-on or turn-off. The pullup current (gate-charging current) is programmable using R23h[5-7]. Use the following equation to set the maximum slew rate:

$$\frac{\Delta V_{OUT}}{\Delta t} = \frac{I_{GATE}}{C_{GD}}$$

where C_{GD} is the total capacitance between GATE and DRAIN of the external FET. Current limit and the capacitive load at the drain control the slew rate during start-up. During current-limit regulation, the MAX5945 manipulates the GATE_voltage to control the voltage at SENSE_. A fast pulldown activates if SENSE_ overshoots the limit threshold. The fast pulldown current increases with the amount of overshoot. The maximum fast pulldown current is 100mA.

During turn-off, when the GATE voltage reaches a value lower than 1.2V, a strong pulldown switch is activated to keep the FET securely off.

Digital Logic

V_{DD} supplies power for the internal logic circuitry. V_{DD} ranges from +1.71V to +3.7V and determines the logic thresholds for the CMOS connections (SDAIN, SDAOUT, SCL, AUTO, SHD_, A_). This voltage range enables the MAX5945 to interface with a nonisolated low-voltage microcontroller. The MAX5945 checks the

digital supply for compatibility with the internal logic. The MAX5945 also features a VDD undervoltage lockout (VDDUVLO) of +1.35V. A VDDUVLO condition keeps the MAX5945 in reset and the ports shut off. Bit 0 in the supply event register shows the status of VDDUVLO (Table 11) after VDD has recovered. All logic inputs and outputs reference to DGND. DGND and AGND are completely isolated internally to the MAX5945. In a completely isolated system, the digital signal can be referenced indifferently to VAGND or VEE or at voltages even higher than AGND (up to 60V). VDD - VDGND must be greater than 3.0V when VDGND \leq (VEE + 3.0V)

When using the AC disconnect detection feature, AGND must be connected directly to DGND and V_{DD} must be greater than +3V. In this configuration, connect DGND to AGND at a single point in the system as close to MAX5945 as possible.

Hardware Shutdown

SHD_ shuts down the respective ports without using the serial interface. Hardware shutdown offers an emergency turn-off feature that allows a fast disconnect of the power supply from the port. Pull SHD_ low to remove power.

Interrupt

The MAX5945 contains an open-drain logic output (INT) that goes low when an interrupt condition exists. R00h and R01h (Tables 5 and 6) contain the definitions of the interrupt registers. The mask register R01h determines events that trigger an interrupt. As a response to an interrupt, the controller reads the status of the event register to determine the cause of the interrupt and takes subsequent actions. Each interrupt event register also contains a clear-on-read (CoR) register. Reading through the CoR register address clears the interrupt. INT remains low when reading the interrupt through the read-only addresses. For example, to clear a startup fault on port 4 read address 09h (see Table 10). Use the global pushbutton bit on register 1Ah (bit 7, Table 22) to clear interrupts, or use a software or hardware reset.

Undervoltage and Overvoltage Protection

The MAX5945 contains several undervoltage and overvoltage protection features. Table 11 in the *Register Map and Description* section shows a detailed list of the undervoltage and overvoltage protection features. An internal VEE undervoltage lockout (VEEUVLO) circuit keeps the MOSFET off and the MAX5945 in reset until VAGND - VEE exceeds 29V for more than 3ms. An internal VEE overvoltage (VEE_OV) circuit shuts down the ports when (VAGND - VEE) exceeds 60V. The digital supply also contains an undervoltage lockout (VDDUVLO).

The MAX5945 also features three other undervoltage and overvoltage interrupts: VEE undervoltage interrupt (VEEUV), VDD undervoltage interrupt (VDDUV), and VDD overvoltage interrupt (VDDOV). A fault latches into the supply events register (Table 11) but the MAX5945 does not shut down the ports with a VEEUV, VDDUV, or VDDOV.

DC Disconnect Monitoring

Setting R13h[DCD_EN_] bits high enable DC load monitoring during a normal powered state. If SENSE_ falls below the DC load disconnect threshold, V_{DCTH}, for more than t_{DISC}, the device turns off power and asserts the LD_DISC_ bit of the corresponding port. t_{DISC} is programmable using R16h[0-1] and R27h[0-3].

AC Disconnect Monitoring

The MAX5945 features AC load disconnect monitoring. Connect an external sine wave to OSC_IN. The oscillator requirements are:

- Frequency x $V_{P-P} = 200V_{P-P} \times Hz \pm 15\%$
- Positive peak voltage > +2V
- Frequency > 60Hz
- A 100Hz \pm 10%, 2V_{P-P} \pm 5%, with \pm 1.2V offset (V_{PEAK} = \pm 2.2V, typ) is recommended.

The MAX5945 buffers and amplifies 3x the external oscillator signal and sends the signal to DET_, where the sine wave is AC coupled to the output. The MAX5945 senses the presence of the load by monitoring the amplitude of the AC current returned to DET_ (see the *Functional Diagram*).

Setting R13h[ACD_EN_] bits high enable AC load disconnect monitoring during the normal powered state. If the AC current peak at the DET_ pin falls below IACTH for more than tDISC, the device turns off power and asserts the LD_DISC_ bit of the corresponding port. IACTH is programmable using R23h[0-3].

An internal comparator checks for a proper amplitude of the oscillator input. If the positive peak of the input sinusoid falls below a safety value of 2V, OSC_FAIL sets and the port shuts down. Power cannot be applied to the ports when ACD_EN is set high and OSC_FAIL is set high. Leave OSC_IN unconnected or connect it to DGND when not using AC disconnect detection.

When using the AC disconnect detection feature, connect AGND directly to DNGD as close as possible to the IC. The MAX5945 also requires a V_{DD} of greater than +3V for this function. See the *Typical Application Circuit* with AC disconnect for other external component requirements.

Table 3. MAX5945 Address

	C	1	0	АЗ	A2	A1	A0	R/W
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Thermal Shutdown

If the MAX5945 die temperature reaches +150°C, an overtemperature fault generates and the MAX5945 shuts down and the MOSFETs turn off. The die temperature of the MAX5945 must cool down below +130°C to remove the overtemperature fault condition. After a thermal shutdown, the part is reset.

Address Inputs

A3, A2, A1, and A0 represent the four LSBs of the chip address, the complete 7-bit chip address (see Table 3).

The four LSBs latch on the low-to-high transition of RESET or after a power-supply start (either on V_{DD} or V_{EE}). Address inputs default high through an internal $50k\Omega$ pullup resistor to V_{DD}. The MAX5945 also responds to the call through a global address 60h (see the *Global Addressing and Alert Response Protocol* section).

I²C-Compatible Serial Interface

The MAX5945 operates as a slave that sends and receives data through an I²C-compatible, 2-wire or 3-wire interface. The interface uses a serial data input line (SDAIN), a serial data output line (SDAOUT), and a serial clock line (SCL) to achieve bidirectional communication between master(s) and slave(s). A master (typically a microcontroller) initiates all data transfers to and from the MAX5945, and generates the SCL clock that synchronizes the data transfer. In most applications, connect the SDAIN and the SDAOUT lines together to form the serial data line (SDA).

Using the separate input and output data lines allows optocoupling with the controller bus when an isolated supply powers the microcontroller.

The MAX5945 SDAIN line operates as an input. The MAX5945 SDAOUT operates as an open-drain output. A pullup resistor, typically 4.7k Ω , is required on SDAOUT. The MAX5945 SCL line operates only as an input. A pullup resistor, typically 4.7k Ω , is required on SCL if there are multiple masters, or if the master in a single-master system has an open-drain SCL output.

Serial Addressing

Each transmission consists of a START condition (Figure 7) sent by a master, followed by the MAX5945 7-bit slave address plus R/\overline{W} bit, a register address byte, one or more data bytes, and finally a STOP condition.

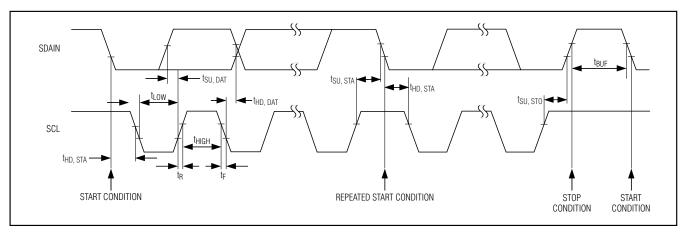


Figure 5. 2-Wire Serial Interface Timing Details

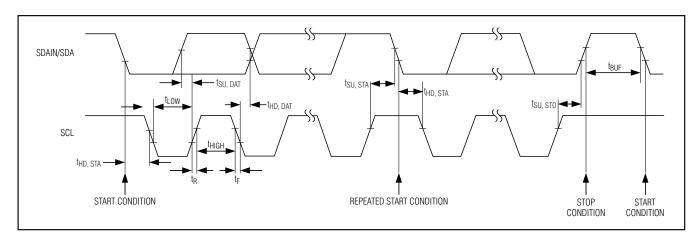


Figure 6. 3-Wire Serial Interface Timing Details

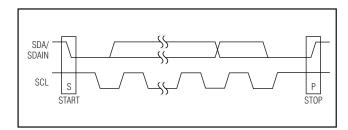


Figure 7. Start and Stop Conditions

SDA / SCL STABLE; CHANGE OF DATA VALID DATA ALLOWED

Figure 8. Bit Transfer

Start and Stop Conditions

Both SCL and SDA remain high when the interface is not busy. A master signals the beginning of a transmission with a START (S) condition by transitioning SDA from high to low while SCL is high. When the master finishes communicating with the slave, the master issues a STOP (P) condition by transitioning SDA from low to high while SCL is high. The stop condition frees the bus for another transmission.

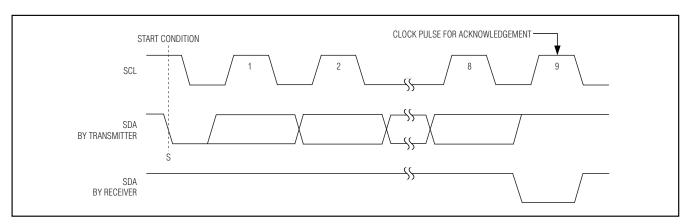


Figure 9. Acknowledge

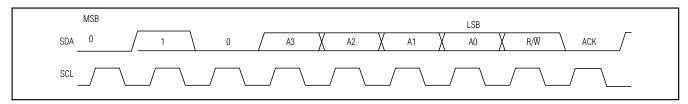


Figure 10. Slave Address

Bit Transfer

Each clock pulse transfers one data bit (Figure 8). The data on SDA must remain stable while SCL is high.

Acknowledge

The acknowledge bit is a clocked 9th bit (Figure 9), which the recipient uses as a handshake receipt of each byte of data. Thus each byte effectively transferred requires 9 bits. The master generates the 9th clock pulse, and the recipient pulls down SDA (or the SDAOUT in the 3-wire interface) during the acknowledge clock pulse, so the SDA line is stable low during the high period of the clock pulse. When the master transmits to the MAX5945, the MAX5945 generates the acknowledge bit. When the MAX5945 transmits to the master, the master generates the acknowledge bit.

Slave Address

The MAX5945 has a 7-bit long slave address (Figure 10). The bit following the 7-bit slave address (bit eight) is the R/\overline{W} bit, which is low for a write command and high for a read command.

010 always represent the first three bits (MSBs) of the MAX5945 slave address. Slave address bits A3, A2, A1, and A0 represent the states of the MAX5945's A3, A2, A1, and A0 inputs, allowing up to sixteen MAX5945 devices to share the bus. The states of the A3, A2, A1,

and A0 latch in upon the reset of the MAX5945 into register R11h. The MAX5945 monitors the bus continuously, waiting for a START condition followed by the MAX5945's slave address. When the MAX5945 recognizes its slave address, it acknowledges and is then ready for continued communication.

Global Addressing and Alert Response Protocol

The global address call is used in writing mode to write the same register to multiple devices (address 0x60). In read mode (address 0x61), the global address call is used as the alert response address. When responding to a global call, the MAX5945 puts out on the data line its own address whenever its interrupt is active and so does every other device connected to the SDAOUT line that has an active interrupt. After every bit is transmitted, the MAX5945 checks that the data line effectively corresponds to the data it is delivering. If it is not, it then backs off and frees the data line. This litigation protocol always allows the part with the lowest address to complete the transmission. The microcontroller can then respond to the interrupt and take proper actions. The MAX5945 does not reset its own interrupt at the end of the alert response protocol. The microcontroller has to do it by clearing the event register through their CoR addresses or activating the CLR_INT pushbutton.

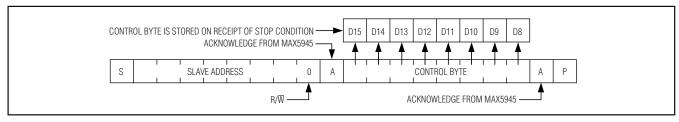


Figure 11. Control Byte Received

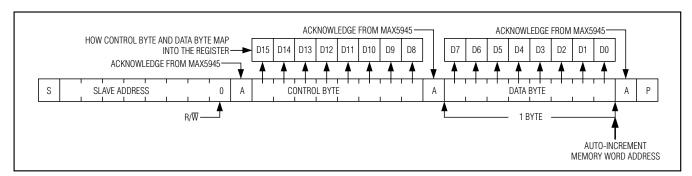


Figure 12. Control and Single Data Byte Received

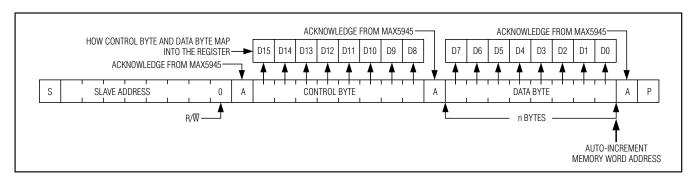


Figure 13. 'n' Data Bytes Received

Message Format for Writing the MAX5945

A write to the MAX5945 comprises of the MAX5945's slave address transmission with the R/W bit set to 0, followed by at least one byte of information. The first byte of information is the command byte (Figure 11). The command byte determines which register of the MAX5945 is written to by the next byte, if received. If the MAX5945 detects a STOP condition after receiving the command byte, then the MAX5945 takes no further action beyond storing the command byte. Any bytes received after the command byte are data bytes. The first data byte goes into the internal register of the

MAX5945 selected by the command byte. If the MAX5945 transmits multiple data bytes before the MAX5945 detects a STOP condition, these bytes store in subsequent MAX5945 internal registers because the control byte address auto-increments.

Any bytes received after the control byte are data bytes. The first data byte goes into the internal register of the MAX5945 selected by the control byte (Figure 8).

If multiple data bytes are transmitted before a STOP condition is detected, these bytes are stored in subsequent MAX5945 internal registers because the control byte address auto-increments.

Table 4. Auto-Increment Rules

COMMAND BYTE ADDRESS RANGE	AUTO-INCREMENT BEHAVIOR
0x00 to 0x26	Command address will auto- increment after byte read or written
0x26	Command address remains at 0x26 after byte written or read

Message Format for Reading

The MAX5945 reads using the MAX5945's internally stored command byte as an address pointer, the same way the stored command byte is used as an address pointer for a write. The pointer auto-increments after reading each data byte using the same rules as for a write. Thus, a read is initiated by first configuring the MAX5945's command byte by performing a write (Figure 12). The master now reads 'n' consecutive bytes from the MAX5945, with the first data byte read from the register addressed by the initialized command byte (Figure 13). When performing read-after-write verification, remember to reset the command byte's address because the stored control byte address auto-increments after the write.

Operation with Multiple Masters

When the MAX5945 operates on a 2-wire interface with multiple masters, a master reading the MAX5945 should use repeated starts between the write that sets the MAX5945's address pointer, and the read(s) that takes the data from the location(s). It is possible for master 2 to take over the bus after master 1 has set up the MAX5945's address pointer but before master 1 has read the data. If master 2 subsequently resets the MAX5945's address pointer then master 1's read may be from an unexpected location.

Command Address Auto-Incrementing

Address auto-incrementing allows the MAX5945 to be configured with fewer transmissions by minimizing the number of times the command address needs to be sent. The command address stored in the MAX5945 generally increments after each data byte is written or read (Table 4). The MAX5945 is designed to prevent overwrites on unavailable register addresses and unintentional wrap-around of addresses.

Register Map And Description

The interrupt register (Table 5) summarizes the event register status and is used to send an interrupt signal (INT goes low) to the controller. Writing a 1 to R1Ah[7] clears all interrupt and events registers. A reset sets R00h to 00h.

INT_EN (R17h[7]) is a global interrupt mask (Table 6). The MASK_ bits activate the corresponding interrupt bits in register R00h. Writing a 0 to INT_EN (R17h[7]) disables the INT output.

A reset sets R01h to AAA00A00b, where A is the state of the AUTO input prior to the reset.

The power event register (Table 7) records changes in the power status of the four ports. Any change in PGOOD_ (R10h[7:4]) sets PG_CHG_ to 1. Any change in the PWR_EN_ (R10h[3:0]) sets PWEN_CHG_ to 1. PG_CHG_ and PWEN_CHG_ trigger on the edges of PGOOD_ and PWR_EN_ and do not depend on the actual level of the bits. The power event register has two addresses. When read through the R02h address, the content of the register is left unchanged. When read through the CoR R03h address, the register content will be cleared. A reset sets R02h/R03h = 00h.

DET_END_/CL_END_ is set high whenever detection/ classification is completed on the corresponding port. A 1 in any of the CL_END_ bits forces R00h[4] to 1. A 1 in any of the DET_END_ bits forces R00h[3] to 1. As with any other events register, the detect event register (Table 8) has two addresses. When read through the R04h address, the content of the register is left unchanged. When read through the CoR R05h address, the register content will be cleared. A reset sets R04h/R05h = 00h.

LD_DISC_ is set high whenever the corresponding port shuts down due to detection of load removal. IMAX_FLT_ is set high when the port shuts down due to an extended overcurrent event after a successful start-up. A 1 in any of the LD_DISC_ bits forces R00h[2] to 1. A 1 in any of the IMAX_FLT_ bits forces R00h[5] to 1. As with any of the other events register, the fault event register (Table 9) has two addresses. When read through the R06h address, the content of the register is left unchanged. When read through the CoR R07h address, the register content will be cleared. A reset sets R06h/R07h = 00h.

Table 5. Interrupt Register

ADDRESS = 00h		h	DESCRIPTION		
SYMBOL	BIT	R/W	DESCRIPTION		
SUP_FLT	7	R	Interrupt signal for supply faults. SUP_FLT is the logic OR of all the bits [7:0] in register R0Ah/R0Bh (Table 8).		
TSTR_FLT	6	R	Interrupt signal for startup failures. TSRT_FLT is the logic OR of bits [7:0] in register R08h/R09h (Table 7).		
IMAX_FLT	5	R	Interrupt signal for current-limit violations. IMAX_FLT is the logic OR of bits [3:0] in register R06h/R07h (Table 6).		
CL_END	4	R	Interrupt signal for completion of classification. CL_END is the logic OR of bits [7:4] in register R04h/R05h (Table 5)		
DET_END	3	R	Interrupt signal for completion of detection. DET_END is the logic OR of bits [3:0] in register R04h/R05h (Table 5).		
LD_DISC	2	R	Interrupt signal for load disconnection. LD_DISC is the logic OR of bits [7:4] in register R06h/R07h (Table 6).		
PG_INT	1	R	Interrupt signal for PGOOD status change. PG_INT is the logic OR of bits [7:4] in register R02h/R03h (Table 4).		
PE_INT	0	R	Interrupt signal for power-enable status change. PEN_INT is the logic OR of bits [3:0] in register R02h/R03h (Table 4).		

Table 6. Interrupt Mask Register

ADDRESS = 01h		h	DESCRIPTION			
SYMBOL	BIT	R/W	DESCRIPTION			
MASK7	7	R/W	Interrupt mask bit 7. A logic high enables the SUP_FLT interrupts. A logic low disables the SUP_FLT interrupts.			
MASK6	6	R/W	Interrupt mask bit 6. A logic high enables the TSTR_FLT interrupts. A low disables the TSTR_FLT interrupts.			
MASK5	5	R/W	Interrupt mask bit 5. A logic high enables the IMAX_FLT interrupts. A logic low disables the IMAX_FLT interrupts.			
MASK4	4	R/W	Interrupt mask bit 4. A logic high enables the CL_END interrupts. A logic low disables the CL_END interrupts.			
MASK3	3	R/W	Interrupt mask bit 3. A logic high enables the DET_END interrupts. A logic low disables the DET_END interrupts.			
MASK2	2	R/W	Interrupt mask bit 2. A logic high enables the LD_DISC interrupts. A logic low disables the LD_DISC interrupts.			
MASK1	1	R/W	Interrupt mask bit 1. A logic high enables the PG_INT interrupts. A logic low disables the PG_INT interrupts.			
MASK0	0	R/W	Interrupt mask bit 0. A logic high enables the PEN_INT interrupts. A logic low disables the PEN_INT interrupts.			

Table 7. Power Event Register

ADDRESS =		02h		DESCRIPTION	
SYMBOL	BIT	R/W	R/W	DESCRIPTION	
PG_CHG4	7	R	CoR	PGOOD change event for port 4	
PG_CHG3	6	R	CoR	PGOOD change event for port 3	
PG_CHG2	5	R	CoR	PGOOD change event for port 2	
PG_CHG1	4	R	CoR	PGOOD change event for port 1	
PWEN_CHG4	3	R	CoR	Power enable change event for port 4	
PWEN_CHG3	2	R	CoR	Power enable change event for port 3	
PWEN_CHG2	1	R	CoR	Power enable change event for port 2	
PWEN_CHG1	0	R	CoR	Power enable change event for port 1	

Table 8. Detect Event Register

ADDRESS	ADDRESS =		05h	DESCRIPTION	
SYMBOL	BIT	R/W	R/W	DESCRIPTION	
CL_END4	7	R	CoR	Classification completed on port 4	
CL_END3	6	R	CoR	Classification completed on port 3	
CL_END2	5	R	CoR	Classification completed on port 2	
CL_END1	4	R	CoR	Classification completed on port 1	
DET_END4	3	R	CoR	Detection completed on port 4	
DET_END3	2	R	CoR	Detection completed on port 3	
DET_END2	1	R	CoR	Detection completed on port 2	
DET_END1	0	R	CoR	Detection completed on port 1	

Table 9. Fault Event Register

ADDRESS	S =	06h	07h	DESCRIPTION	
SYMBOL	BIT	R/W	R/W	DESCRIPTION	
LD_DISC4	7	R	CoR	Disconnect on port 4	
LD_DISC3	6	R	CoR	Disconnect on port 3	
LD_DISC2	5	R	CoR	Disconnect on port 2	
LD_DISC1	4	R	CoR	Disconnect on port 1	
IMAX_FLT4	3	R	CoR	Overcurrent on port 4	
IMAX_FLT3	2	R	CoR	Overcurrent on port 3	
IMAX_FLT2	1	R	CoR	Overcurrent on port 2	
IMAX_FLT1	0	R	CoR	Overcurrent on port 1	

Table 10. Startup Event Register

ADDRESS =		08h	09h	DESCRIPTION		
SYMBOL	BIT	R/W	R/W	DESCRIPTION		
IVC4	7	R	CoR	Class overcurrent flag for port 4		
IVC3	6	R	CoR	Class overcurrent flag for port 3		
IVC2	5	R	CoR	Class overcurrent flag for port 2		
IVC1	4	R	CoR	Class overcurrent flag for port 1		
STRT_FLT4	3	R	CoR	Startup failed on port 4		
STRT_FLT3	2	R	CoR	Startup failed on port 3		
STRT_FLT2	1	R	CoR	Startup failed on port 2		
STRT_FLT1	0	R	CoR	Startup failed on port 1		

Table 11. Supply Event Register

ADDRESS =		0Ah	0Bh	DESCRIPTION		
SYMBOL	BIT	R/W	R/W	DESCRIPTION		
TSD	7	R	CoR	Overtemperature shutdown		
V _{DD_OV}	6	R	CoR	V _{DD} overvoltage condition		
V _{DD_UV}	5	R	CoR	V _{DD} undervoltage condition		
VEE_UVLO	4	R	CoR	VEE undervoltage lockout condition		
V _{EE} _OV	3	R	CoR	V _{EE} overvoltage condition		
V _{EE_UV}	2	R	CoR	V _{EE} undervoltage condition		
OSC_FAIL	1	R	CoR	Oscillator amplitude is below limit		
V _{DD_UVLO}	0	R	CoR	V _{DD} undervoltage lockout condition		

Table 12. Port Status Registers

ADDRESS = 0Ch	DESCRIPTION		
SYMBOL	BIT	R/W	DESCRIPTION
Reserved	7	R	Reserved
	6	R	CLASS_[2]
CLASS_	5	R	CLASS_[1]
	4	R	CLASS_[0]
Reserved	3	R	Reserved
	2	R	DET_[2]
DET_ST_	1	R	DET_[1]
	0	R	DET_[0]

If the port remains in current limit or the PGOOD condition is not met at the end of the startup period, the port shuts down and the corresponding STRT_FLT_ is set to 1. A 1 in any of the STRT_FLT_ bits forces R00h[6] to 1. IVC_ is set to 1 whenever the port current exceeds the

maximum allowed limit for the class (determined during the classification process). A 1 in any of IVC_ forces R00h[6] to 1. When the CL_DISC (R17h[2]) is set to 1, the port will also limit the load current according to its class as specified in the *Electrical Characteristics* table. As with any other events register, the startup event register (Table 10) has two addresses. When read through the R08h address, the content of the register is left unchanged. When read through the CoR R09h address, the register content will be cleared. A reset sets R08h/R09h = 00h.

The MAX5945 continuously monitors the power supplies and sets the appropriate bits in the supply event register (Table 11). V_{DD_OV} / V_{EE_OV} is set to 1 whenever V_{DD} / V_{EE} exceeds its overvoltage threshold. V_{DD_UV} / V_{EE_UV} is set to 1 whenever V_{DD} / V_{EE} falls below its undervoltage threshold.

OSC_FAIL is set to 1 whenever the amplitude of the oscillator signal at the OSC_input falls below a level that might compromise the AC disconnect detection